

RoHS Compliant Product
A suffix of "-C" specifies halogen-free

DESCRIPTION

The SID9575 provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

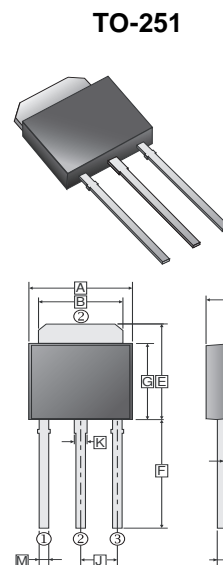
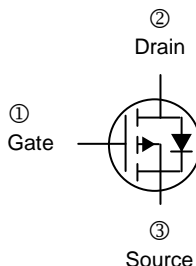
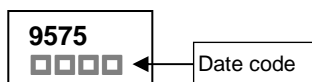
FEATURES

- Simple Drive Requirement
- Lower On-resistance
- Fast Switching Characteristic

APPLICATION

The through-hole version (TO-251) is available for low-profile applications and suited for low voltage applications such as DC / DC converters.

MARKING:



| REF. | Millimeter | | REF. | Millimeter | |
|------|------------|------|------|------------|------|
| | Min. | Max. | | Min. | Max. |
| A | 6.40 | 6.80 | G | 5.40 | 5.80 |
| B | 5.20 | 5.50 | H | 0.90 | 1.50 |
| C | 2.20 | 2.40 | J | 2.30 | |
| D | 0.45 | 0.55 | K | 0.60 | 0.90 |
| E | 6.80 | 7.20 | M | 0.50 | 0.70 |
| F | 7.20 | 7.80 | P | 0.45 | 0.60 |

ABSOLUTE MAXIMUM RATINGS

| Parameter | | Symbol | Ratings | Unit |
|--|-------------------------------|-----------------|----------|----------------|
| Drain-Source Voltage | | V_{DS} | -60 | V |
| Gate-Source Voltage | | V_{GS} | ± 25 | V |
| Continuous Drain Current | $V_{GS}=10V, T_C=25^\circ C$ | I_D | -15 | A |
| | $V_{GS}=10V, T_C=100^\circ C$ | | -9.5 | A |
| Pulsed Drain Current ¹ | | I_{DM} | -45 | A |
| Total Power Dissipation @ $T_C = 25^\circ C$ | | P_D | 36 | W |
| Thermal Resistance Junction-case | | $R_{\theta JC}$ | 3.5 | $^\circ C / W$ |
| Thermal Resistance Junction-ambient | | $R_{\theta JA}$ | 110 | $^\circ C / W$ |
| Linear Derating Factor | | | 0.29 | $W / ^\circ C$ |
| Operating Junction & Storage temperature | | T_J, T_{STG} | -55~150 | $^\circ C$ |

ELECTRICAL CHARACTERISTICS ($T_A = 25^\circ\text{C}$ unless otherwise specified)

| Parameter | Symbol | Min | Typ | Max | Unit | Test Conditions | |
|--|--------------------------------|-------------------------|-------|------|--------|--|----------------------------------|
| Drain-Source Breakdown Voltage | BV_{DSS} | -60 | - | - | V | $V_{GS}=0, I_D = -250\mu\text{A}$ | |
| Breakdown Voltage Temperature Coefficient | $\Delta BV_{DSS} / \Delta T_J$ | - | -0.06 | - | V / °C | Reference to 25°C, $I_D = -1\text{mA}$ | |
| Gate Threshold Voltage | $V_{GS(th)}$ | -1 | - | -3 | V | $V_{DS}=V_{GS}, I_D = -250\mu\text{A}$ | |
| Forward Trans-conductance | g_{fs} | - | 14 | - | S | $V_{DS} = -10\text{V}, I_D = -9\text{A}$ | |
| Gate-Source Leakage Current | I_{GSS} | - | - | ±100 | nA | $V_{GS} = \pm 25\text{V}$ | |
| Drain-Source Leakage Current | I_{DSS} | $T_J=25^\circ\text{C}$ | - | - | -1 | uA | $V_{DS} = -60\text{V}, V_{GS}=0$ |
| | | $T_J=150^\circ\text{C}$ | - | - | -25 | | $V_{DS} = -48\text{V}, V_{GS}=0$ |
| Static Drain-Source On-Resistance ² | $R_{DS(ON)}$ | - | - | 90 | mΩ | $V_{GS} = -10\text{V}, I_D = -12\text{A}$ | |
| | | - | - | 120 | | $V_{GS} = -4.5\text{V}, I_D = -9\text{A}$ | |
| Total Gate Charge ² | Q_g | - | 17 | 27 | nC | $I_D = -9\text{A}$ $V_{DS} = -48\text{V}$ $V_{GS} = -4.5\text{V}$ | |
| Gate-Source Charge | Q_{gs} | - | 5 | - | | | |
| Gate-Drain ("Miller") Charge | Q_{gd} | - | 6 | - | | | |
| Turn-on Delay Time ² | $T_{d(on)}$ | - | 10 | - | nS | $V_{DS} = -30\text{V}$ $I_D = -9\text{A}$ $V_{GS} = -10\text{V}$ $R_G = 3.3\Omega$ $R_D = 3.3\Omega$ | |
| Rise Time | T_r | - | 19 | - | | | |
| Turn-off Delay Time | $T_{d(off)}$ | - | 46 | - | | | |
| Fall Time | T_f | - | 53 | - | | | |
| Input Capacitance | C_{iss} | - | 1660 | 2660 | pF | $V_{GS}=0$ $V_{DS} = -25\text{V}$ $f = 1\text{MHz}$ | |
| Output Capacitance | C_{oss} | - | 160 | - | | | |
| Reverse Transfer Capacitance | C_{rss} | - | 100 | - | | | |
| Source-Drain Diode | | | | | | | |
| Forward On Voltage ² | V_{SD} | - | - | -1.2 | V | $I_S = -9\text{A}, V_{GS}=0$ | |
| Reverse Recovery Time ² | T_{rr} | - | 56 | - | nS | $I_S = -9\text{A}, V_{GS}=0$ $di/dt = 100\text{A} / \mu\text{s}$ | |
| Reverse Recovery Charge | Q_{rr} | - | 159 | - | nC | | |

Notes:

- Pulse width limited by safe operating area.
- Pulse width $\leq 300\mu\text{s}$, duty cycle $\leq 2\%$

CHARACTERISTIC CURVES

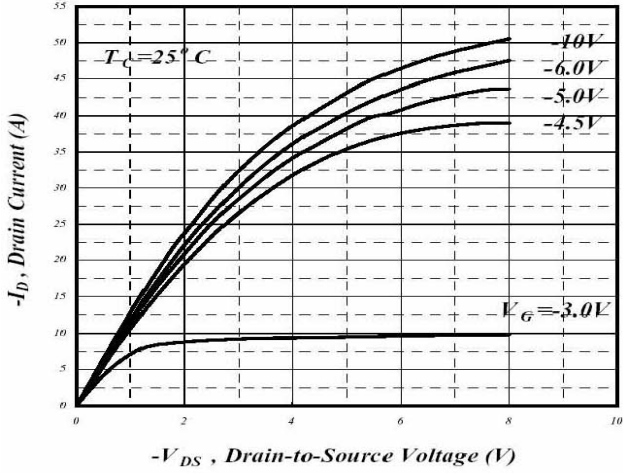


Fig 1. Typical Output Characteristics

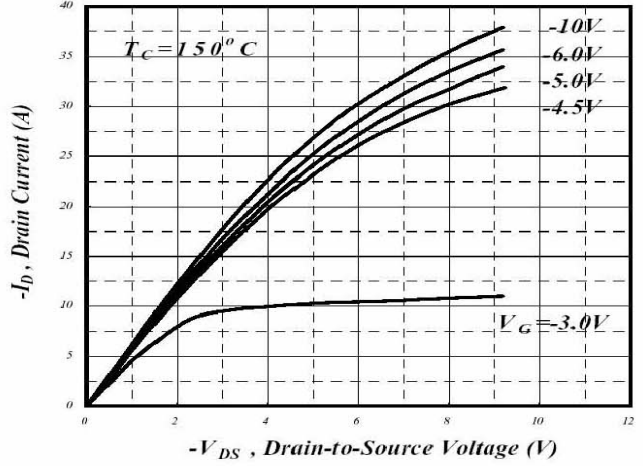


Fig 2. Typical Output Characteristics

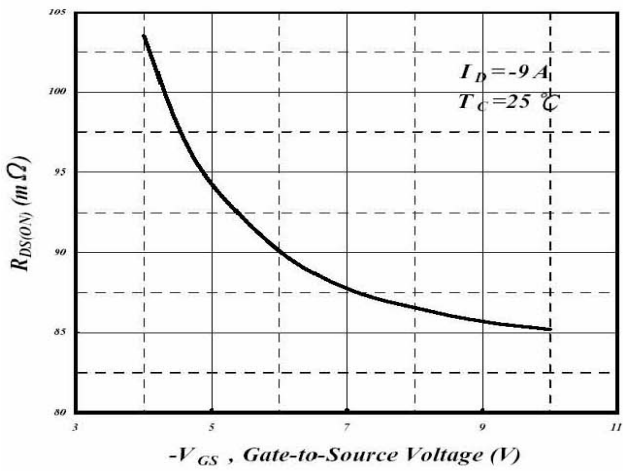


Fig 3. On-Resistance v.s. Gate Voltage

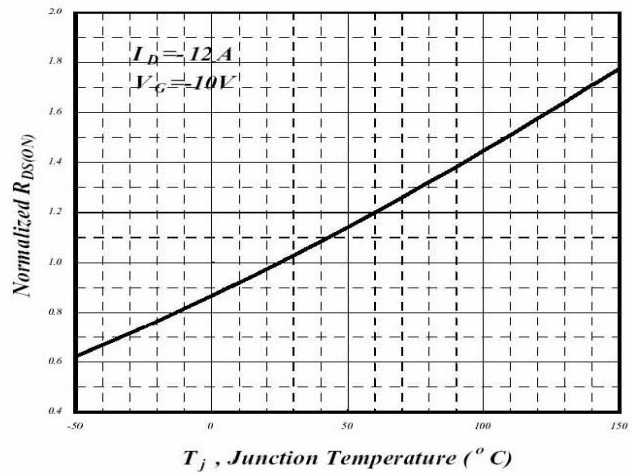


Fig 4. Normalized On-Resistance v.s. Junction Temperature

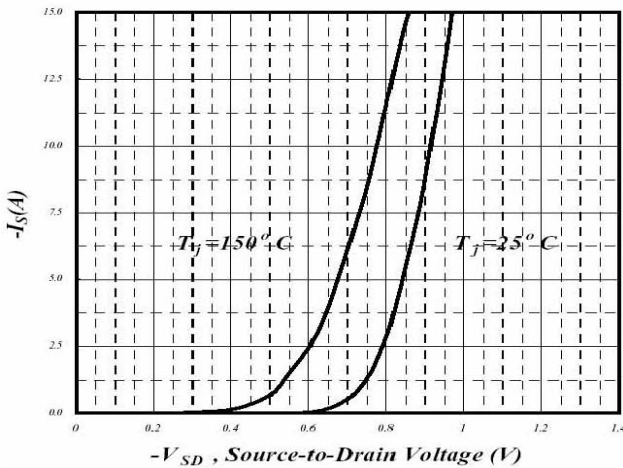


Fig 5. Forward Characteristics of Reverse Diode

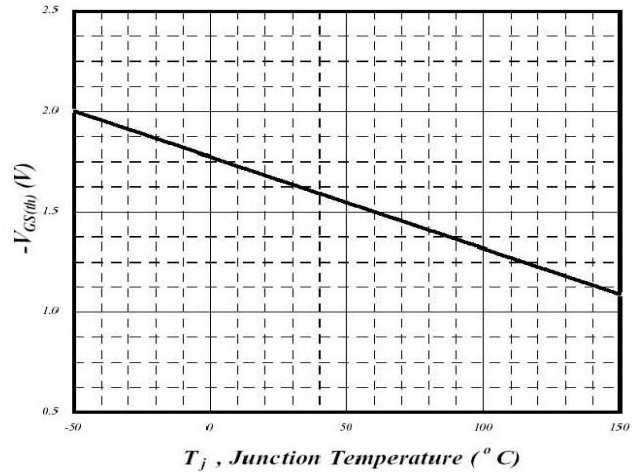


Fig 6. Gate Threshold Voltage v.s. Junction Temperature

CHARACTERISTIC CURVES

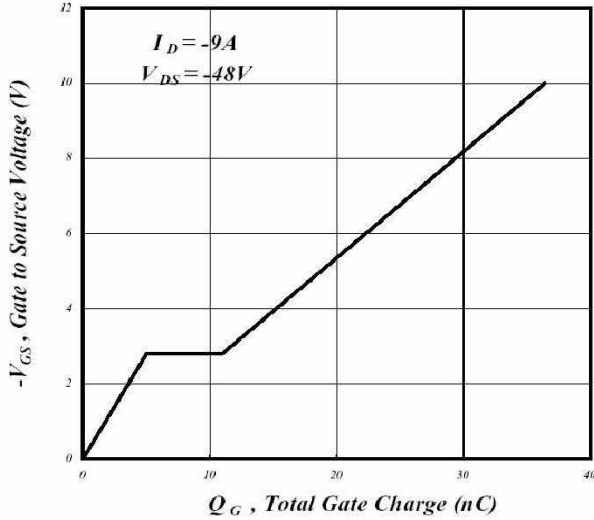


Fig 7. Gate Charge Characteristics

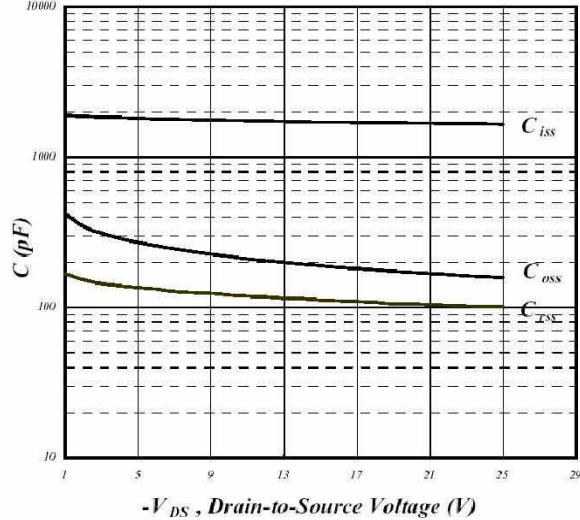


Fig 8. Typical Capacitance Characteristics

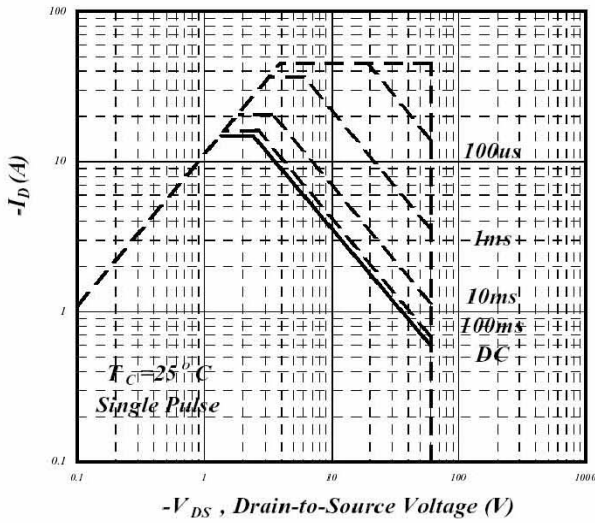


Fig 9. Maximum Safe Operating Area

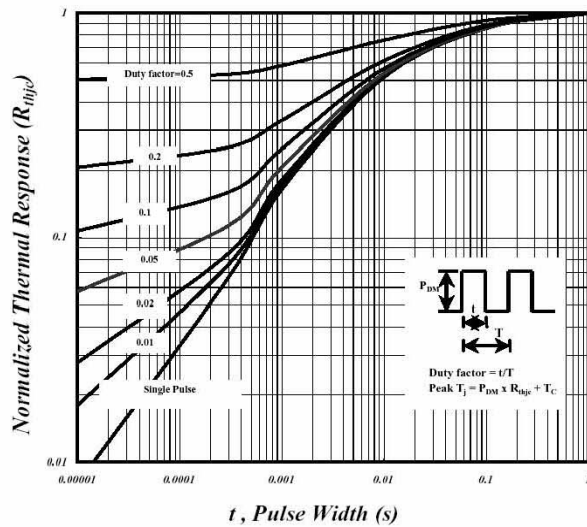


Fig 10. Effective Transient Thermal Impedance

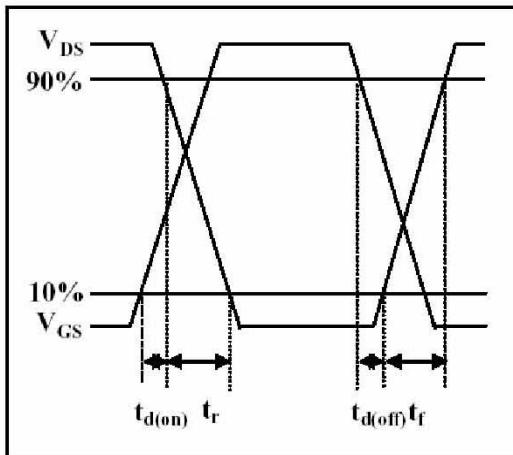


Fig 11. Switching Time Waveform

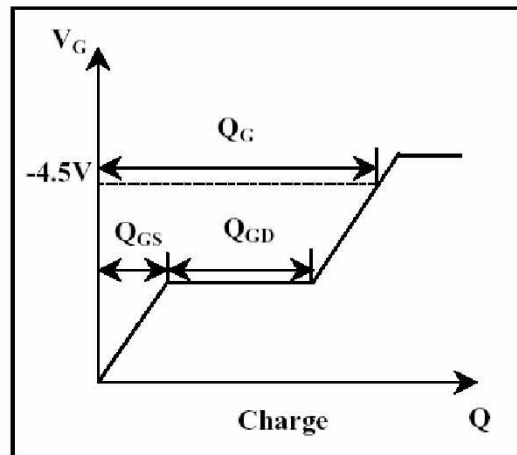


Fig 12. Gate Charge Waveform

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